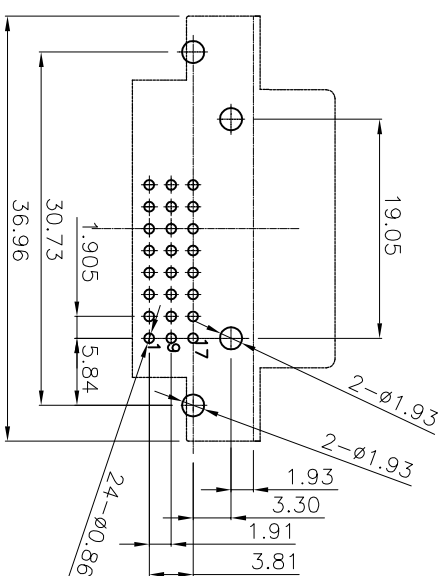
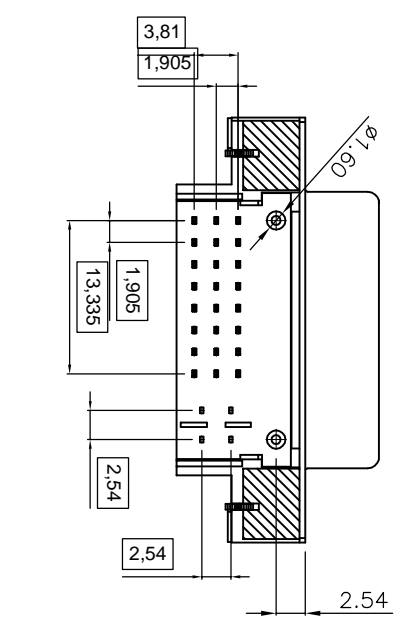


1. HOUSING: THERMOPLASTIC (UL 94V-0).
 2. COVER: THERMOPLASTIC (UL 94V-0).
 3. TERMINAL: COPPER ALLOY,
GOLD PLATED ON CONTACT AREA,
TIN PLATED ON SOLDER TAILS,
NICKEL UNDER PLATED OVERALL.
 4. BOARD LOCK: SPCC, TIN PLATED OVER NICKEL.
 5. SHELL: SPCC, NICKEL PLATED OVERALL.
 6. RIVET: Zn ALLOY, NICKEL PLATED OVERALL.
1. MATING FORCE: 4.5KG/MAX.
 2. UNMATING FORCE: 1.0-4.0KG.
 3. DIELECTRIC WITHSTANDING VOLTAGE:
500V AC R.M.S. FOR ONE MINUTE.
 4. INSULATION RESISTANCE:
1000MΩ MIN AT 500V DC.
 5. CONTACT RESISTANCE: 30mΩ MAX.
 6. OPERATING TEMPERATURE : -25°C TO +85°C.



RECOMMEND PCB LAYOUT
TOLERANCE: ±0.05
TOP VIEW

REV	ECN NO	DESCRIPTION	DATE
A	JIONS-DVI-0012		2011/02/01

Jions 北京玖盟启明电子科技有限公司

X	±0.30	APPD	Mr.Wu	TITLE:
X	±0.20			
XX	±0.10	CHKD:	Mr.Wu	24PIN 焊板式 母头+D型铜箔
.XXX	±0.05			
X	±2°	DR:	Gus chong	PART NO: JIONS-0039
X	±1°			
UNITS:	mm	SCALE:	1:1	DWG NO: 客户图
				WWW.JIONS.COM.CN
				SHEET:10/1
				REV: